



**DECLARATION FOR PATENT APPLICATION (JOINT OR SOLE)**

(Under 37 CFR § 1.63; with Power of Attorney)

**FROMMER LAWRENCE & HAUG LLP**

PLH File No. 450100-02171

As a below named inventor, I hereby declare that:  
My residence, post office address and citizenship are as stated below next to my name,  
I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first  
and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is  
sought on the invention ENTITLED:

**SIGNAL PROCESSING CIRCUIT**

the specification of which

\_\_\_\_\_ is attached hereto.

X was filed on November 18, 1999 as Application Serial No. 09/442,727,  
with amendment(s) through \_\_\_\_\_ (if applicable, give dates).

I hereby state that I have reviewed and understand the contents of the above-identified specification, including  
the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose to the United States Patent and Trademark Office all information known to me  
to be material to patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56.

I hereby claim foreign priority benefits under Title 35, United States Code, § 119 of any foreign application(s)  
for patent or inventor's certificate listed below and have also identified below any foreign application for patent or  
inventor's certificate having a filing date before that of the application on which priority is claimed:

<u>Prior Foreign Application(s)</u>	<u>List additional applications on separate page:</u>	<u>Priority Claimed:</u>		
<u>Number:</u>	<u>Country:</u>	<u>Filed (Day/Month/Year):</u>	<u>Yes</u>	<u>No</u>
10-329973	Japan	19 November 1998	X	

I hereby claim the benefit under Title 35, United States Code, § 120 of any United States application(s) listed  
below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United  
States application in the manner provided by the first paragraph of Title 35, United States Code § 112, I acknowledge the  
duty to disclose to the United States Patent and Trademark Office all information known to me to be material to  
patentability as defined in Title 37, Code of Federal Regulations, Sec. 1.56, which became available between the filing  
date of the prior application and the national or PCT international filing date of this application:

<u>Prior U.S. Application(s)</u>	<u>List additional applications on separate page:</u>	
<u>Appln. Ser. Number:</u>	<u>Filed (Day/Month/Year):</u>	<u>Status (patented, pending, abandoned):</u>

I hereby appoint WILLIAM S. FROMMER, Registration No. 25,506, and DENNIS M. SMID, Registration No. 34,930  
or their duly appointed associate, my attorneys, with full power of substitution and revocation, to prosecute this  
application, to make alterations and amendments therein, to file continuation and divisional applications thereof, to  
receive the Patent, and to transact all business in the Patent and Trademark Office and in the Courts in connection  
therewith, and specify that all communications about the application are to be directed to the following correspondence  
address:

WILLIAM S. FROMMER, Esq.  
c/o FROMMER LAWRENCE & HAUG LLP  
745 Fifth Avenue  
New York, New York 10151

Direct all telephone calls to:  
(212) 588-0800  
to the attention of:  
WILLIAM S. FROMMER

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on  
information and belief are believed to be true; and further that these statements were made with the knowledge that  
willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of  
Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application  
or any patent issued thereon.

INVENTOR(S):

Signature: \_\_\_\_\_

Full name of sole or first inventor: \_\_\_\_\_

Residence: \_\_\_\_\_

Citizenship: \_\_\_\_\_

*Sadaharu Sato*

Sadaharu SATO  
Tokyo, Japan  
Japan

Date: Feb 10, 2000

Signature: \_\_\_\_\_

Full name of 2nd joint inventor (if any): \_\_\_\_\_

Residence: \_\_\_\_\_

Citizenship: \_\_\_\_\_

Date: \_\_\_\_\_

Signature: \_\_\_\_\_

Full name of 3rd joint inventor (if any): \_\_\_\_\_

Residence: \_\_\_\_\_

Citizenship: \_\_\_\_\_

Date: \_\_\_\_\_

(Similarly list additional inventors on separate page)

Post Office Address(es) of inventor(s): \_\_\_\_\_

[If all inventors have the same post office address]

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134 Koudo-Cho, Hodogaya-Ku  
Yokohama-Shi, Kanagawa, Japan

Note: In order to qualify for reduced fees available to Small Entities, each inventor and any other individual or entity  
having rights to the invention must also sign an appropriate separate "Verified Statement (Declaration) Claiming for  
Supporting a Claim by Another for Small Entity Status" form (e.g. for Independent Inventor, Small Business Concern,  
Nonprofit Organization, Individual Non-Inventor).

Note: A post office address must be provided for each inventor.